SK 100 GD 126 T



SEMITOP[®]4

3-phase bridge inverter

SK 100 GD 126 T

Target Data

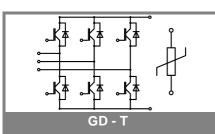
Features

- One screw mounting module
- Fully compatible with SEMITOP[®]1,2,3
- Improved thermal resistance performances by aluminium oxide substrate
- Trench IGBT technology
- CAL technology FWD
- Integrated NTC temperature sensor

Typical Applications

- Inverter up to 50 kVA
- Typ. motor power 22kW

1) $V_{CE,SAT}$, V_F = chip level value

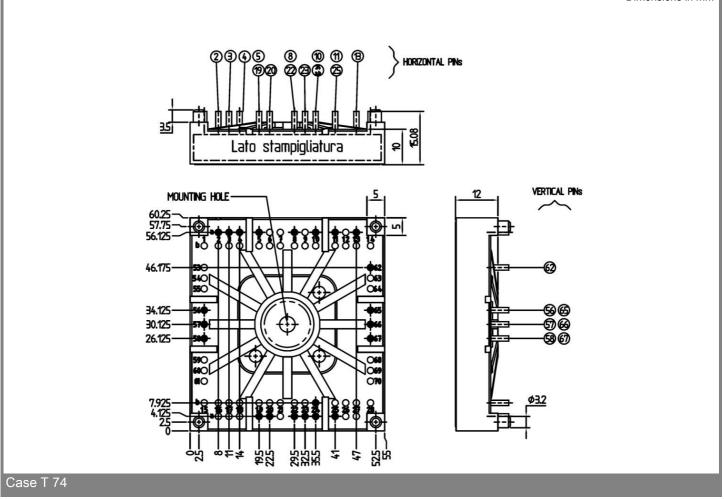


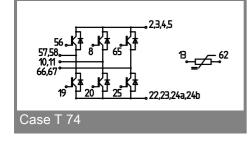
| Absolute Maximum Ratings | | Ts = 25 °C, unless otherwise | Ts = 25 °C, unless otherwise specified | | | | | |
|-------------------------------------|--|------------------------------|--|--|--|--|--|--|
| Symbol | Conditions | Values | Units | | | | | |
| IGBT - Inverter | | | | | | | | |
| V _{CES} | | 1200 | V | | | | | |
| I _C | T _s = 25 (70) °C | 114 (86) | А | | | | | |
| I _{CRM} | , t _p = 1 ms | 228 | А | | | | | |
| V _{GES} | | ± 20 | V | | | | | |
| Т _ј | | -40 +150 | °C | | | | | |
| Diode - Inverter | | | | | | | | |
| I _F | T _s = 25 (70) °C | 118 (88) | А | | | | | |
| I _{FRM} | $I_{FRM} = 2xI_{Fnom}, t_p = 1 \text{ ms}$ | 236 | А | | | | | |
| T _j | | -40 +150 | °C | | | | | |
| Rectifier | • | | • | | | | | |
| V _{RRM} | | | V | | | | | |
| I _{FAV} /I _{TAV} | T _s = °C | | А | | | | | |
| I _{FSM} / I _{TSM} | t _p = ms , sin ° ,T _j = °C | | А | | | | | |
| I ² t | t _p = ms , sin ° ,T _j = °C | | A²s | | | | | |
| T _j | | | °C | | | | | |
| T _{sol} | Terminals, 10 s | 260 | °C | | | | | |
| T _{stg} | | -40 +125 | °C | | | | | |
| V _{isol} | AC, 1 min. / 1 s | 2500 / 3000 | V | | | | | |
| Characte | riction | Ts = 25 °C. unless otherwise | e specified | | | | | |

| Characteristics | | Ts = 25 °C | Ts = 25 °C, unless otherwise specified | | | |
|--|---|------------|--|--------------------------------|---------------|--|
| Symbol | Conditions | min. | typ. | max. | Units | |
| IGBT - Ir | verter ¹⁾ | | | | | |
| V _{CEsat} V _{GE(th)} V _{CE(TO)} | I _C = 100 A, T _j = 25 (125) °C V _{GE} = V _{CE} , I _C = 4 mA T _i = 25 °C (125) °C | 5 | 1,7 (2,15) 5,8 1 (0,9) | 2,1 (2,45) 6,5 1,2 (1,1) | V V V | |
| r _T | $T_j = 25 \text{ °C} (125) \text{ °C}$ $V_{CE} = 25 V_{GE} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$ | | 7 (11) | 9,5 (14) | mΩ nF | |
| C _{ies} C _{oes} | V _{CE} = 25 V _{GE} = 0 V, f = 1 MHz | | - | | nF nF | |
| C _{res} R _{th(j-s)} | V _{CE} = 25 V _{GE} = 0 V, f = 1 MHz per IGBT | | 0,4 | | K/W | |
| t _{d(on)} | under following conditions | | - | | ns | |
| t _r | $V_{CC} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$ | | - | | ns | |
| t _{d(off)} | I _C = 105 A, T _j = 125 °C | | - | | ns | |
| t _f ⊏ | $R_{Gon} = R_{Goff} = 5 \Omega$ inductive load | | - 13,1 | | ns mJ | |
| E _{on} E _{off} | | | 13 | | mJ | |
| Diode - I | nverter ¹⁾ | | | | | |
| $V_F = V_{EC}$ $V_{(TO)}$ r_T | $ I_F = 100 \text{ A}, T_j = 25 (125) \text{ °C} T_j = 25 \text{ °C} (125) \text{ °C} T_i = 25 \text{ °C} (125) \text{ °C} T_i = 25 \text{ °C} (125) \text{ °C} $ | | 1 (1,5) 1,18 (1) 3,2 (5) | | V V mΩ | |
| R _{th(j-s)} | per diode | | 0,55 | | K/W | |
| I _{RRM} Q _{rr} E _{rr} | under following conditions $I_F = A, V_R = V$ $V_{GE} = 0 V, T_j = 125 °C$ $di_F/dt = - A/\mu s$ | | - | | Α μC mJ | |
| Diode re | ctifier | | | | | |
| V _F V _(TO) r _T | $I_F = A, T_j = 25 °C$ $T_j = °C$ $T_j = °C$ | | | | V V mΩ | |
| R _{th(j-s)} | per diode | | | | K/W | |
| Tempera | atur sensor | | | | | |
| R _{ts} | 5 %, T _r = 25 (100) °C | | 5000(493) | | Ω | |
| Mechani | cal data | | | | | |
| w M _s | Mounting torque | | 60 3,5 | | g Nm | |
| 5 | | | | | 1 | |

SK 100 GD 126 T

Dimensions in mm





This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.